

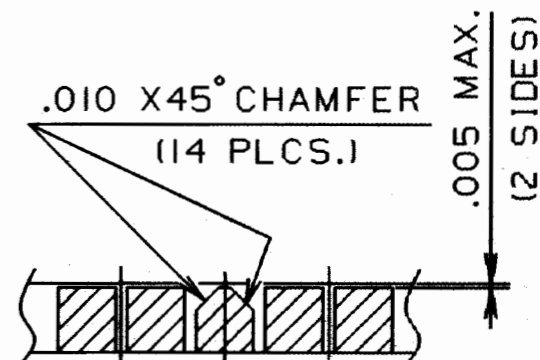
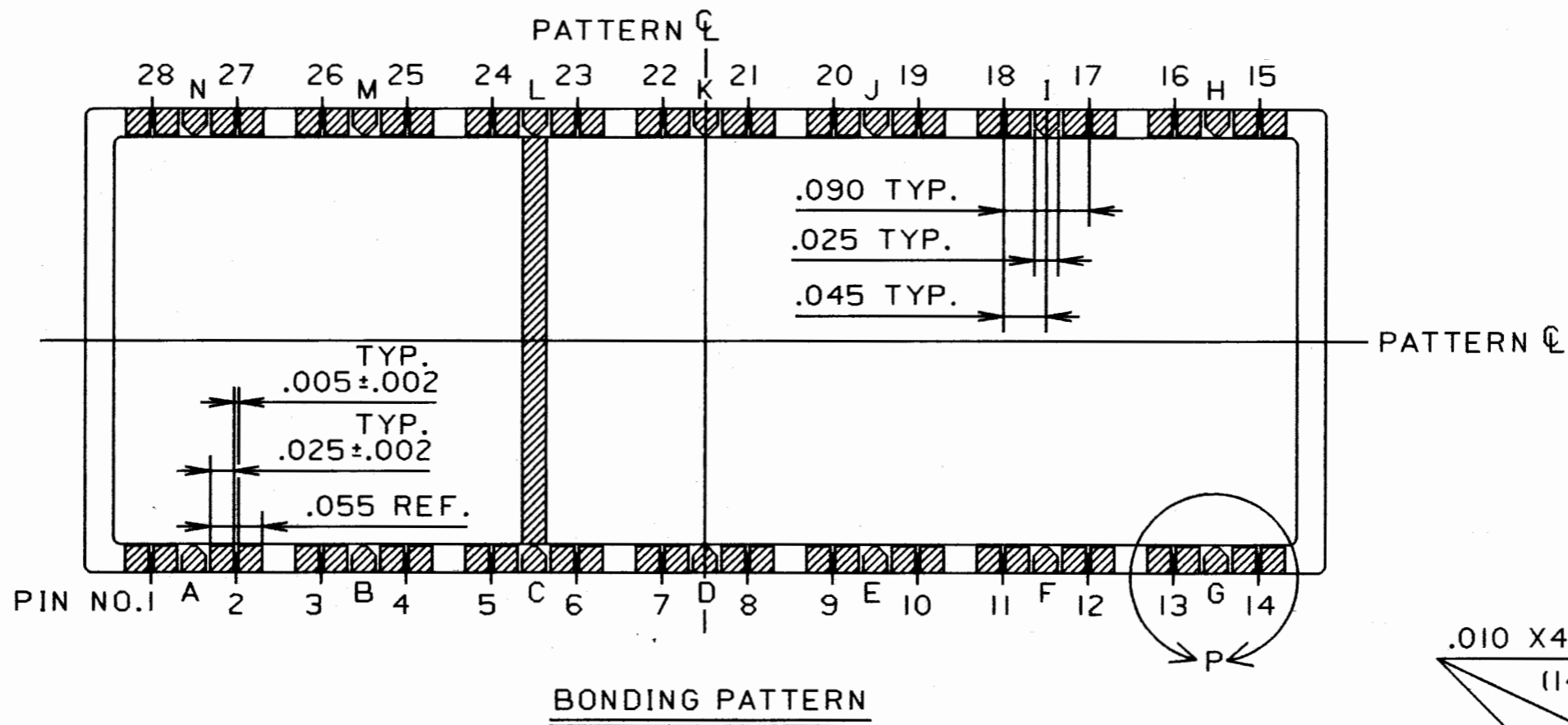
- NOTES
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. SEAL AREA TO BE METALLIZED.
 3. DIE ATTACH AREA TO BE NOT METALLIZED.
 4. SEAL RING TO BE FLOATING FROM ANY PINS.
 5. CAMBER: .005/IN. N.L.T. .004
 6. BONDING PATTERN A,B,C,D,E,F,G,H,I,J,K,L,M,N TO BE ELECTRICALLY CONNECTED TO SEAL RING.
 7. LEAD RESISTANCE 0.1Ω MAX.

HBO28AAG81-1 SK=0 D=N

MODIFICATION						NAME	28 LEAD HYBRID PACKAGE	TOLERANCE	UNLESS OTHERWISE SPECIFIED	DRAWN	CHECKED	APPROVED	DATE
						SCALE	4 / 1	±.005	THIRD ANGLE PROJECTION	M.S	S.T	T.A	K.M
						MATERIAL	AS INDICATED						JUL.23'92
							KYOCERA CORPORATION			DRAWING NO.			SHEET
							KYOTO JAPAN			KD-H92681			1/2

CHANGED

DATE DRAWN CHECKED APPROVED



DETAIL - P

MODIFICATION					NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
					28 LEAD HYBRID PACKAGE	UNLESS OTHERWISE SPECIFIED	M.S	S.T	T.A K.M	JUL.23.92
					SCALE 6/1	MATERIAL				
						THIRD ANGLE PROJECTION				
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO.		SHEET
					KD-H92681			2/2		